

UNISONIC TECHNOLOGIES CO., LTD

2N60-C **Power MOSFET**

2A, 600V N-CHANNEL **POWER MOSFET**

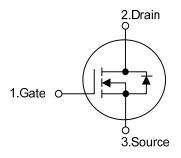
DESCRIPTION

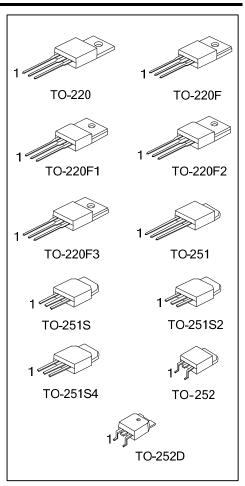
The UTC 2N60-C is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 4.6 Ω @ V_{GS} = 10V, I_D =1A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL





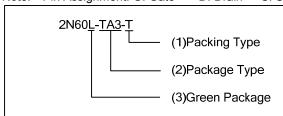
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2N60-C **Power MOSFET**

ORDERING INFORMATION

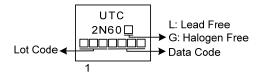
| Ordering Number | | Package | Pin Assignment | | | Packing | |
|-----------------|--------------|----------|----------------|---|---|-----------|--|
| Lead Free | Halogen Free | Fackage | 1 | 2 | 3 | Facking | |
| 2N60L-TA3-T | 2N60G-TA3-T | TO-220 | G | D | S | Tube | |
| 2N60L-TF3-T | 2N60G-TF3-T | TO-220F | G | D | S | Tube | |
| 2N60L-TF1-T | 2N60G-TF1-T | TO-220F1 | G | D | S | Tube | |
| 2N60L-TF2-T | 2N60G-TF2-T | TO-220F2 | G | D | S | Tube | |
| 2N60L-TF3T-T | 2N60G-TF3T-T | TO-220F3 | G | D | S | Tube | |
| 2N60L-TM3-T | 2N60G-TM3-T | TO-251 | G | D | S | Tube | |
| 2N60L-TMS-T | 2N60G-TMS-T | TO-251S | G | D | S | Tube | |
| 2N60L-TMS2-T | 2N60G-TMS2-T | TO-251S2 | G | D | S | Tube | |
| 2N60L-TMS4-T | 2N60G-TMS4-T | TO-251S4 | G | D | S | Tube | |
| 2N60L-TN3-R | 2N60G-TN3-R | TO-252 | G | D | S | Tape Reel | |
| 2N60L-TND-R | 2N60G-TND-R | TO-252D | G | D | S | Tape Reel | |

Note: Pin Assignment: G: Gate D: Drain S: Source



- (1) T: Tube, R: Tape Reel
- (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F3, TM3: TO-251 TMS: TO-251S, TMS2: TO-251S2, TMS4: TO-251S4, TN3: TO-252, TND: TO-252D
- (3) L: Lead Free, G: Halogen Free and Lead Free

MARKING





■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|------------------------------------|---|------------------|------------|------|
| Drain-Source Voltage | | $V_{	t DSS}$ | 600 | V |
| Gate-Source Voltage | | V_{GSS} | ±30 | V |
| Avalanche Current (Note 2) | | I_{AR} | 2.0 | Α |
| Drain Current | Continuous | I_{D} | 2.0 | Α |
| | Pulsed (Note 2) | I_{DM} | 8.0 | Α |
| Avalanche Energy | Single Pulsed (Note 3) | E _{AS} | 140 | mJ |
| | Repetitive (Note 2) | E_{AR} | 4.5 | mJ |
| Peak Diode Recovery dv/dt (Note 4) | | dv/dt | 3.7 | V/ns |
| Power Dissipation | TO-220 | | 54 | |
| | TO-220F/TO-220F1 | | 23 | |
| | TO-220F3 TO-220F2 | P_{D} | 24 | W |
| | TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D | | 44 | |
| Junction Temperature | | TJ | +150 | °C |
| Operating Temperature | | T _{OPR} | -55 ~ +150 | °C |
| Storage Temperature | | T _{STG} | -55 ~ +150 | °C |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by T_J
- 3. L=70mH, I_{AS} =2.0A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 2A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

| PARAMETER | | SYMBOL | SYMBOL RATINGS | | |
|---------------------|---|---------------|----------------|------|--|
| Junction to Ambient | TO-220F/TO-220F1/ TO-220F2/TO-220F3 | | 62.5 | | |
| | TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D | θ_{JA} | 100 | °C/W | |
| Junction to Case | TO-220F/TO-220F1 TO-220F3 | | 5.5 | °C/W | |
| | TO-220F2 | Δ | 5.43 | | |
| | TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D | θус | 2.87 | C/VV | |



ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

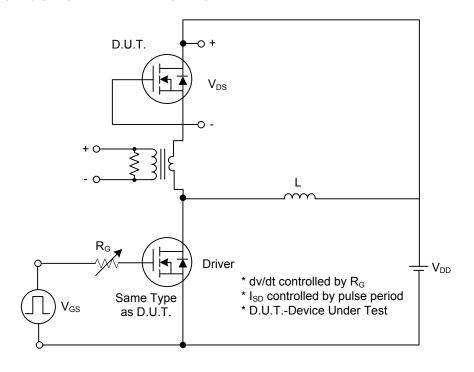
| PARAMETER | | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|-------------------|--------------------------------------|--|-----|-----|------|------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-Source Breakdown Voltage | | BV _{DSS} | $V_{GS} = 0V, I_D = 250\mu A$ | 600 | | | V |
| Drain-Source Leakage Current | | Ince | $V_{DS} = 600V, V_{GS} = 0V$ | | | 10 | μΑ |
| | | | $V_{DS} = 480V, T_{C} = 125^{\circ}C$ | | | 100 | μΑ |
| Gate-Source Leakage Current | Forward | - I _{GSS} | $V_{GS} = 30V, V_{DS} = 0V$ | | | 100 | nA |
| | Reverse | | $V_{GS} = -30V, V_{DS} = 0V$ | | | -100 | nA |
| Breakdown Voltage Temperature Coefficient | | $\triangle BV_{DSS}/\triangle T_{J}$ | I _D =250μA, Referenced to 25°C | | 0.4 | | V/°C |
| ON CHARACTERISTICS | | | | | | | |
| Gate Threshold Voltage | | $V_{GS(TH)}$ | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2.0 | | 4.0 | V |
| Static Drain-Source On-State Resi | stance | R _{DS(ON)} | $V_{GS} = 10V, I_{D} = 1A$ | | | 4.6 | Ω |
| DYNAMIC CHARACTERISTICS | | | | | | | |
| Input Capacitance | Input Capacitance | | | | 300 | 350 | pF |
| Output Capacitance | | C _{ISS} | V_{DS} =25V, V_{GS} =0V, f =1MHz | | 45 | 50 | pF |
| Reverse Transfer Capacitance | | C_{RSS} | | | 10 | 13 | pF |
| SWITCHING CHARACTERISTICS | S | _ | | | =. | - | ā. |
| Total Gate Charge | | Q_G | V _{DS} =50V, V _{GS} =10V, I _D =1.3A | | 35 | | nC |
| Gate-Source Charge | | Q_GS | $I_G = 100 \mu A \text{ (Note 1, 2)}$ | | 3.5 | | nC |
| Gate-Drain Charge | | Q_GD | iig = 100μΑ (Note 1, 2) | | 2.5 | | nC |
| Turn-On Delay Time | | t _{D (ON)} | | | 30 | | ns |
| Turn-On Rise Time | | t_R | $V_{DD} = 30V$, $I_D = 0.5A$, $R_G = 25\Omega$, | | 25 | | ns |
| Turn-Off Delay Time | | t _{D(OFF)} | V _{GS} =10V (Note 1, 2) | | 90 | | ns |
| Turn-Off Fall Time | | t_{F} | | | 25 | | ns |
| DRAIN-SOURCE DIODE CHARA | CTERISTIC | CS | | | a. | | ā. |
| Drain-Source Diode Forward Voltage | | V_{SD} | $V_{GS} = 0 \text{ V}, I_{SD} = 2.0 \text{ A}$ | | | 1.4 | V |
| Continuous Drain-Source Current | | I _{SD} | | | | 2.0 | Α |
| Pulsed Drain-Source Current | | I _{SM} | | | | 8.0 | Α |
| Reverse Recovery Time | | t _{rr} | $V_{GS} = 0 \text{ V}, I_{SD} = 2A,$ | | 275 | | ns |
| Reverse Recovery Charge | | Q _{RR} | di/dt = 100 A/μs (Note 1) | | 1.1 | | μC |

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%.

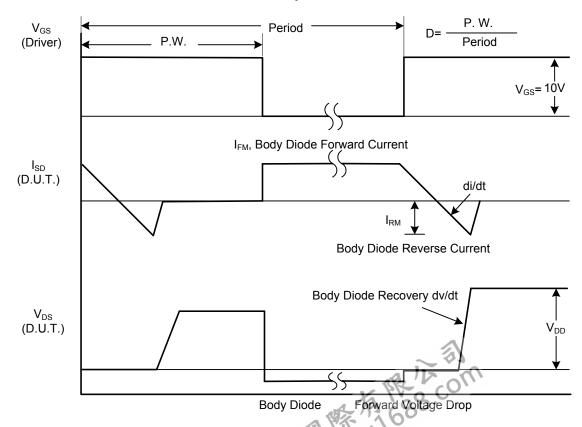


^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

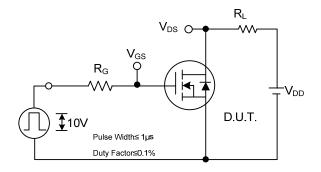


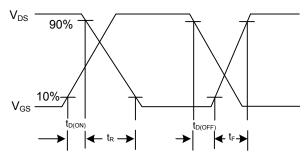
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

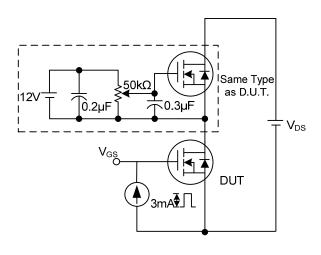
TEST CIRCUITS AND WAVEFORMS (Cont.)

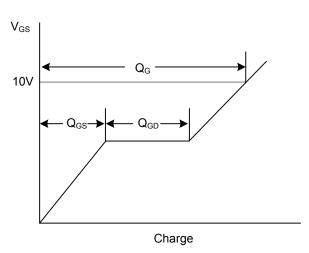




Switching Test Circuit

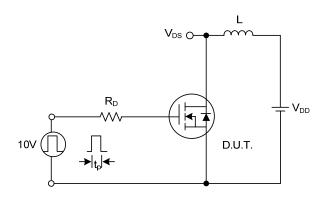
Switching Waveforms

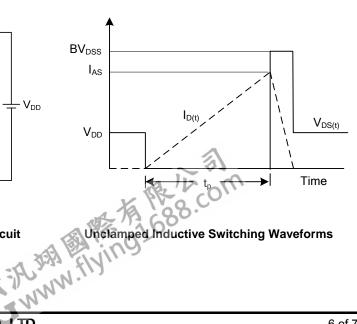




Gate Charge Test Circuit

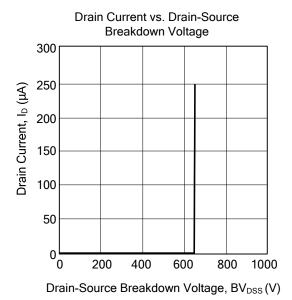
Gate Charge Waveform

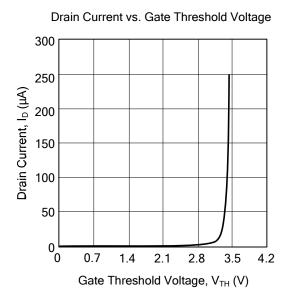


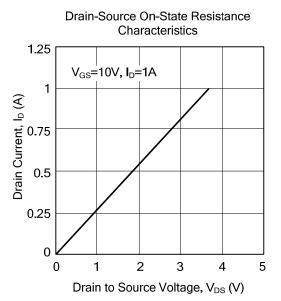


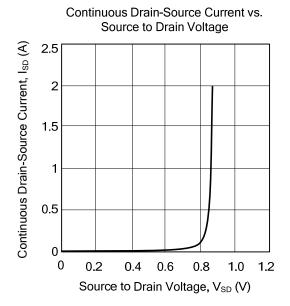
Unclamped Inductive Switching Test Circuit

■ TYPICAL CHARACTERISTICS









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